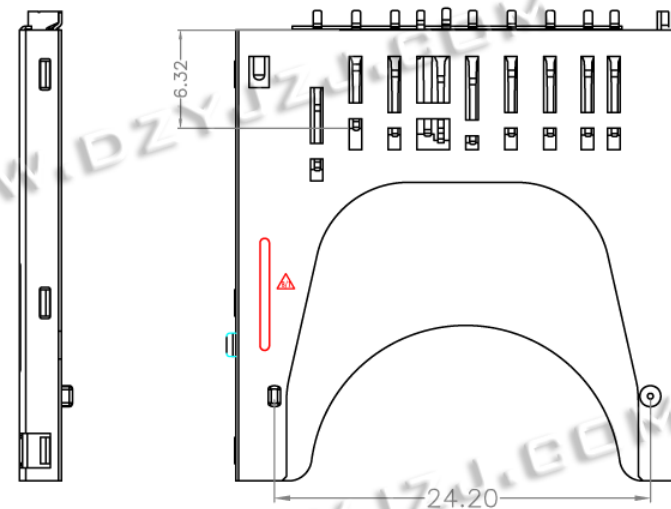
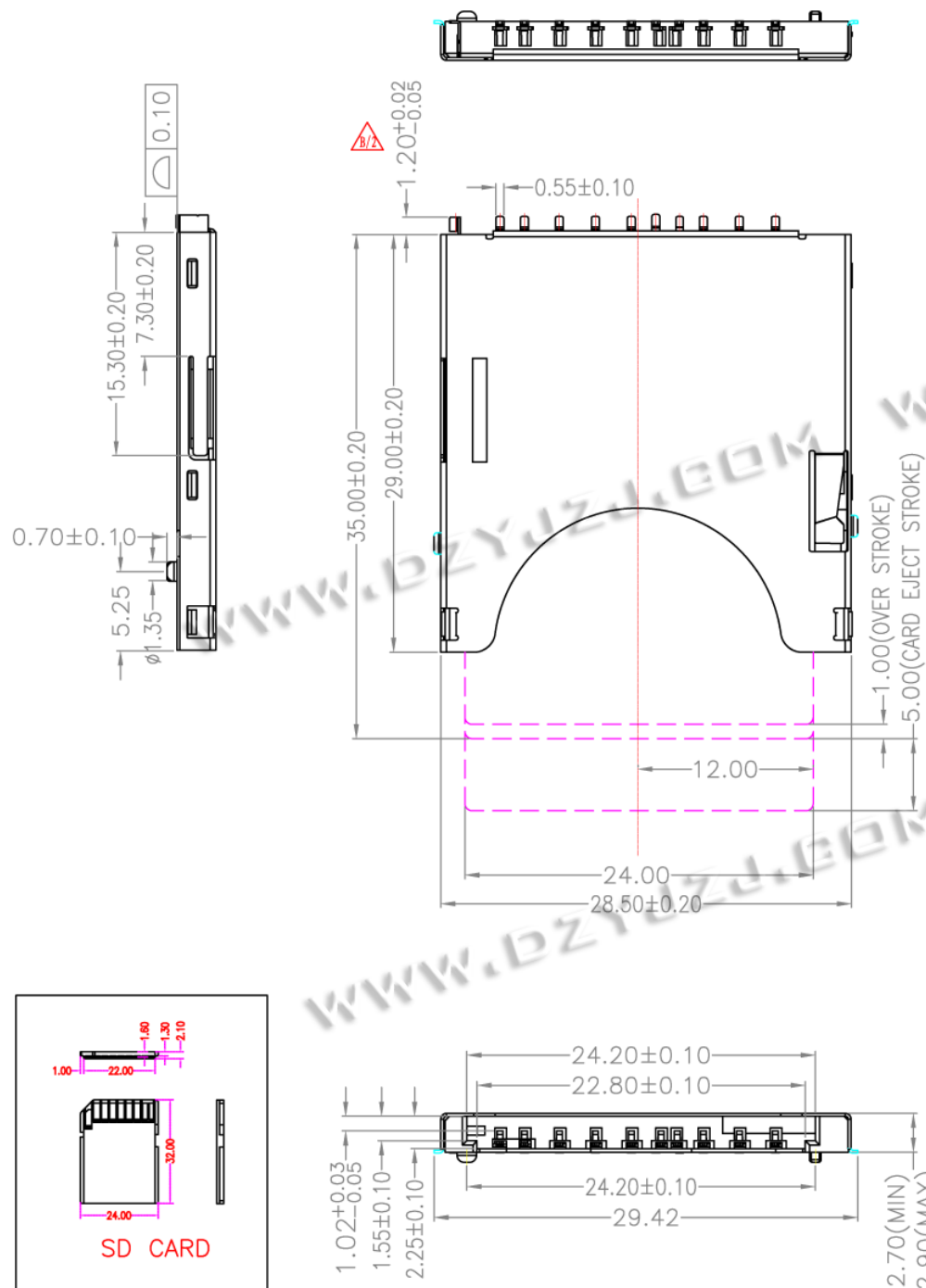




NOTES:

1.MATERIAL:

HOUSING: HIGH TEMPERATURE THERMOPLASTIC
UL94V_0,COLOR:BLACK.

CONTACT: COPPER ALLOYS.

COVER: COPPER ALLOYS OR STEEL.

2.PLATING:

UNDERPLATE: NICKEL.

CONTACT AREA: GOLD OVER NICKEL.

SOLDER AREA: TIN OVER NICKEL.

3.MULTIMEDIA CARD COMPATIBLE



深圳市华宇创精密电子有限公司

TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X.' ±2' X.X' ±0.5'	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: SD PUSH 定位片向外
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO. HVC36-SD11-275
	APPROVED BY: 邱国夷	DATE : 2014-02-23	DRAW NO: HVC-SD16030216
	SCALE:1:1	SIZE: A4	SHEET NO. 1 OF 1